

OP777/OP727/OP747

FEATURES

- Low Offset Voltage: 100 μV Max
- Low Input Bias Current: 10 nA Max
- Single-Supply Operation: 3.0 V to 30 V
- Dual-Supply Operation: ± 1.5 V to ± 15 V
- Low Supply Current: 300 $\mu\text{A}/\text{Amp}$ Max
- Unity Gain Stable
- No Phase Reversal

APPLICATIONS

- Current Sensing (Shunt)
- Line or Battery-Powered Instrumentation
- Remote Sensors
- Precision Filters
- OP727 SOIC Pin-Compatible with LT1013

GENERAL DESCRIPTION

The OP777, OP727, and OP747 are precision single, dual, and quad rail-to-rail output single-supply amplifiers featuring micropower operation and rail-to-rail output ranges. These amplifiers provide improved performance over the industry standard OP07 with ± 15 V supplies, and offer the further advantage of true single-supply operation down to 3.0 V, and smaller package options than any other high-voltage precision bipolar amplifier. Outputs are stable with capacitive loads of over 500 pF. Supply current is less than 300 μA per amplifier at 5 V. 500 Ω series resistors protect the inputs, allowing input signal levels several volts above the positive supply without phase reversal.

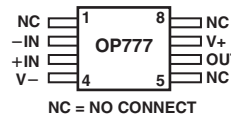
Applications for these amplifiers include both line-powered and portable instrumentation, remote sensor signal conditioning, and precision filters.

The OP777, OP727, and OP747 are specified over the extended industrial (-40°C to $+85^\circ\text{C}$) temperature range. The OP777, single, is available in 8-lead MSOP and 8-lead SOIC packages. The OP747, quad, is available in 14-lead TSSOP and narrow 14-lead SO packages. Surface-mount devices in TSSOP and MSOP packages are available in tape and reel only.

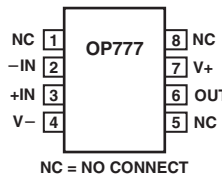
The OP727, dual, is available in 8-lead TSSOP and 8-lead SOIC packages. The OP727 8-lead SOIC pin configuration differs from the standard 8-lead operational amplifier pinout.

FUNCTIONAL BLOCK DIAGRAMS

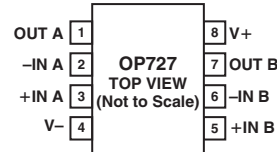
8-Lead MSOP
(RM-8)



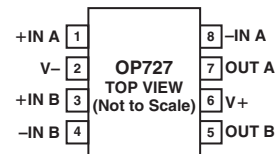
8-Lead SOIC
(R-8)



8-Lead TSSOP
(RU-8)

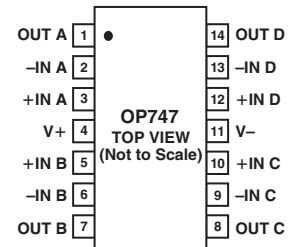


8-Lead SOIC
(R-8)

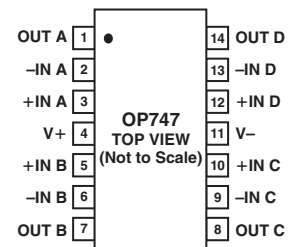


NOTE: THIS PIN CONFIGURATION DIFFERS FROM THE STANDARD 8-LEAD OPERATIONAL AMPLIFIER PINOUT.

14-Lead SOIC
(R-14)



14-Lead TSSOP
(RU-14)



SIMILAR LOW POWER PRODUCTS

Supply Voltage/ Supply Current	1.8 V/1 μA	1.8 V/20 μA	1.8 V/25 μA	1.8 V/50 μA	2.5 V/1 mA	3.0 V/200 μA	4 V/215 μA
Single	AD8500	ADA4051-1	AD8505	AD8603/AD8613	ADA4528-1		
Dual	AD8502	ADA4051-2	AD8506	AD8607/AD8617		ADA4091-2	AD8622
Quad	AD8504		AD8508	AD8609/AD8619		ADA4091-4	AD8624

REV. D

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices.

OP777/OP727/OP747—SPECIFICATIONS

ELECTRICAL CHARACTERISTICS (@ $V_S = 5.0\text{ V}$, $V_{CM} = 2.5\text{ V}$, $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage OP777	V_{OS}	$+25^\circ\text{C} < T_A < +85^\circ\text{C}$		20	100	μV
		$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		50	200	μV
Offset Voltage OP727/OP747		$+25^\circ\text{C} < T_A < +85^\circ\text{C}$		30	160	μV
		$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		60	300	μV
Input Bias Current	I_B	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		5.5	11	nA
Input Offset Current	I_{OS}	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.1	2	nA
Input Voltage Range			0		4	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = 0\text{ V to }4\text{ V}$	104	110		dB
Large Signal Voltage Gain	A_{VO}	$R_L = 10\text{ k}\Omega$, $V_O = 0.5\text{ V to }4.5\text{ V}$	300	500		V/mV
Offset Voltage Drift OP777	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.3	1.3	$\mu\text{V}/^\circ\text{C}$
Offset Voltage Drift OP727/OP747	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.4	1.5	$\mu\text{V}/^\circ\text{C}$
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$I_L = 1\text{ mA}$, $-40^\circ\text{C to }+85^\circ\text{C}$	4.88	4.91		V
Output Voltage Low	V_{OL}	$I_L = 1\text{ mA}$, $-40^\circ\text{C to }+85^\circ\text{C}$		126	140	mV
Output Circuit	I_{OUT}	$V_{DROPOUT} < 1\text{ V}$		± 10		mA
POWERSUPPLY						
Power Supply Rejection Ratio	PSRR	$V_S = 3\text{ V to }30\text{ V}$	120	130		dB
Supply Current/Amplifier OP777	I_{SY}	$V_O = 0\text{ V}$		220	270	μA
		$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		270	320	μA
Supply Current/Amplifier OP727/OP747		$V_O = 0\text{ V}$		235	290	μA
		$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		290	350	μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 2\text{ k}\Omega$		0.2		V/ μs
Gain Bandwidth Product	GBP			0.7		MHz
NOISE PERFORMANCE						
Voltage Noise	$e_{n\text{p-p}}$	0.1 Hz to 10 Hz		0.4		$\mu\text{V p-p}$
Voltage Noise Density	e_n	$f = 1\text{ kHz}$		15		$\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	i_n	$f = 1\text{ kHz}$		0.13		$\text{pA}/\sqrt{\text{Hz}}$

NOTES

Typical specifications: >50% of units perform equal to or better than the “typical” value.

Specifications subject to change without notice.

ELECTRICAL CHARACTERISTICS (@ ±15 V, $V_{CM} = 0$ V, $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage OP777	V_{OS}	$+25^\circ\text{C} < T_A < +85^\circ\text{C}$ $-40^\circ\text{C} < T_A < +85^\circ\text{C}$		30 50	100 200	μV μV
Offset Voltage OP727/OP747	V_{OS}	$+25^\circ\text{C} < T_A < +85^\circ\text{C}$ $-40^\circ\text{C} < T_A < +85^\circ\text{C}$		30 50	160 300	μV μV
Input Bias Current	I_B	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		5	10	nA
Input Offset Current	I_{OS}	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.1	2	nA
Input Voltage Range			-15		+14	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = -15$ V to +14 V	110	120		dB
Large Signal Voltage Gain	A_{VO}	$R_L = 10$ k Ω , $V_O = -14.5$ V to +14.5 V	1,000	2,500		V/mV
Offset Voltage Drift OP777	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.3	1.3	$\mu\text{V}/^\circ\text{C}$
Offset Voltage Drift OP727/OP747	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +85^\circ\text{C}$		0.4	1.5	$\mu\text{V}/^\circ\text{C}$
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$I_L = 1$ mA, -40°C to $+85^\circ\text{C}$	+14.9	+14.94		V
Output Voltage Low	V_{OL}	$I_L = 1$ mA, -40°C to $+85^\circ\text{C}$		-14.94	-14.9	V
Output Circuit	I_{OUT}			± 30		mA
POWERSUPPLY						
Power Supply Rejection Ratio	PSRR	$V_S = \pm 1.5$ V to ± 15 V	120	130		dB
Supply Current/Amplifier OP777	I_{SY}	$V_O = 0$ V $-40^\circ\text{C} < T_A < +85^\circ\text{C}$		300 350	350 400	μA μA
Supply Current/Amplifier OP727/747		$V_O = 0$ V $-40^\circ\text{C} < T_A < +85^\circ\text{C}$		320 375	375 450	μA μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 2$ k Ω		0.2		V/ μs
Gain Bandwidth Product	GBP			0.7		MHz
NOISE PERFORMANCE						
Voltage Noise	$e_{n\text{p-p}}$	0.1 Hz to 10 Hz		0.4		$\mu\text{V p-p}$
Voltage Noise Density	e_n	$f = 1$ kHz		15		$\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	i_n	$f = 1$ kHz		0.13		$\text{pA}/\sqrt{\text{Hz}}$

Specifications subject to change without notice.

OP777/OP727/OP747

ABSOLUTE MAXIMUM RATINGS^{1, 2}

Supply Voltage	36 V
Input Voltage	$-V_S - 5 \text{ V}$ to $+V_S + 5 \text{ V}$
Differential Input Voltage	\pm Supply Voltage
Output Short-Circuit Duration to GND	Indefinite
Storage Temperature Range	
RM, R, RU Packages	-65°C to $+150^\circ\text{C}$
Operating Temperature Range	
OP777/OP727/OP747	-40°C to $+85^\circ\text{C}$
Junction Temperature Range	
RM, R, RU Packages	-65°C to $+150^\circ\text{C}$
Lead Temperature Range (Soldering, 60 sec)	300°C
Electrostatic Discharge (Human Body Model)	2000 V max

Package Type	θ_{JA} ³	θ_{JC}	Unit
8-Lead MSOP (RM)	190	44	$^\circ\text{C}/\text{W}$
8-Lead SOIC (R)	158	43	$^\circ\text{C}/\text{W}$
8-Lead TSSOP (RU)	240	43	$^\circ\text{C}/\text{W}$
14-Lead SOIC (R)	120	36	$^\circ\text{C}/\text{W}$
14-Lead TSSOP (RU)	180	35	$^\circ\text{C}/\text{W}$

NOTES

¹Absolute maximum ratings apply at 25°C , unless otherwise noted.

²Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

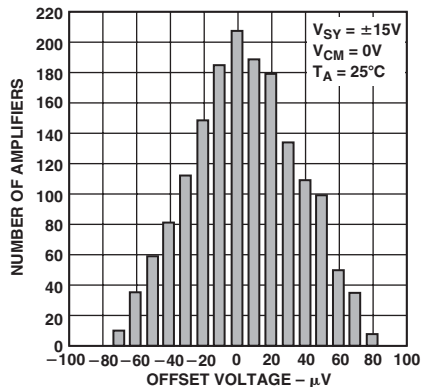
³ θ_{JA} is specified for worst-case conditions, i.e., θ_{JA} is specified for device soldered in circuit board for surface-mount packages.

CAUTION

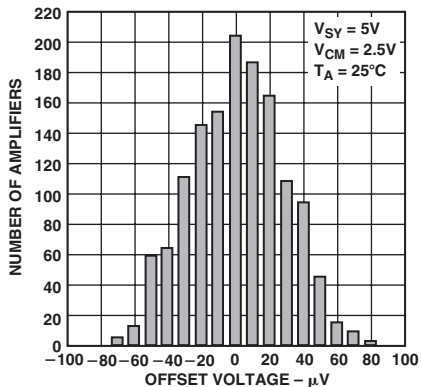
ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the OP777/OP727/OP747 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



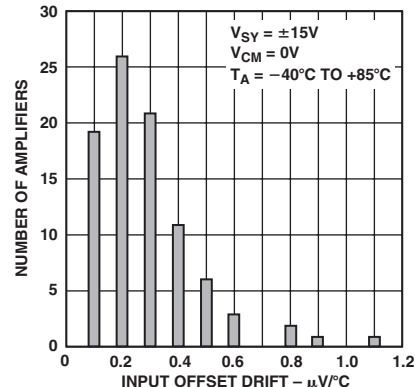
Typical Performance Characteristics—OP777/OP727/OP747



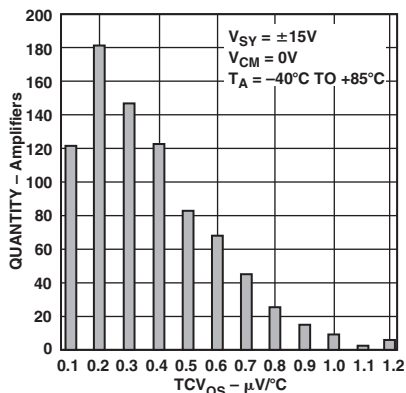
TPC 1. OP777 Input Offset Voltage Distribution



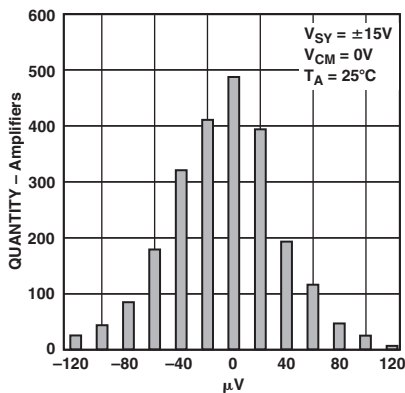
TPC 2. OP777 Input Offset Voltage Distribution



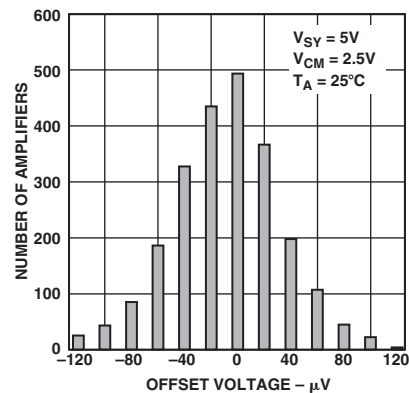
TPC 3. OP777 Input Offset Voltage Drift Distribution



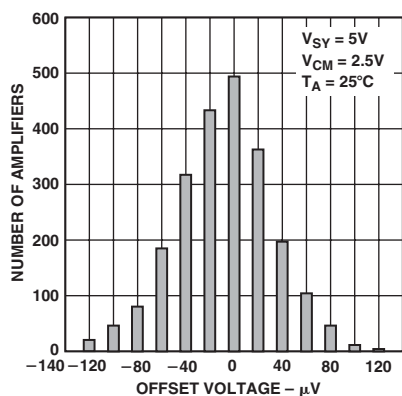
TPC 4. OP727/OP747 Input Offset Voltage Drift (TCV_{OS} Distribution)



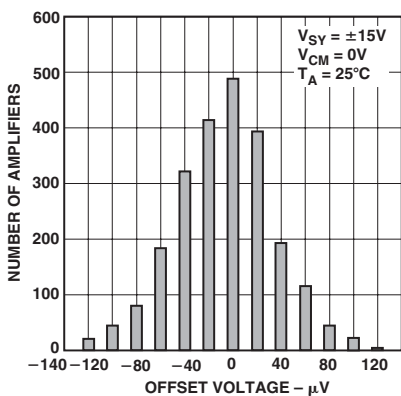
TPC 5. OP747 Input Offset Voltage Distribution



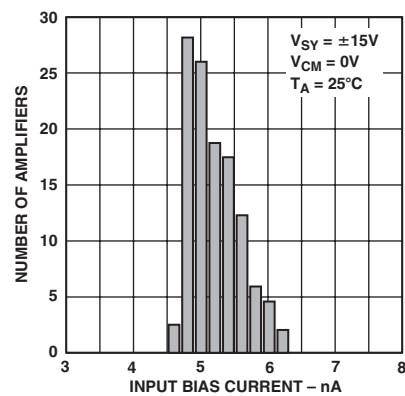
TPC 6. OP747 Input Offset Voltage Distribution



TPC 7. OP727 Input Offset Voltage Distribution

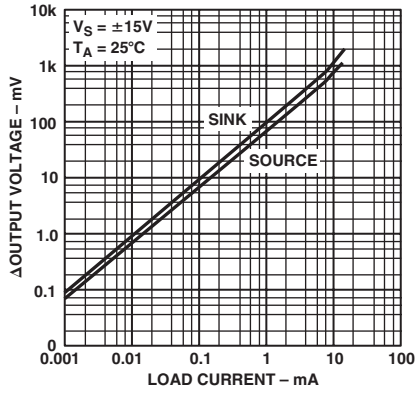


TPC 8. OP727 Input Offset Voltage Distribution

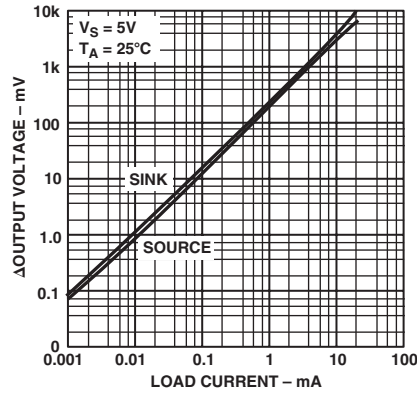


TPC 9. Input Bias Current Distribution

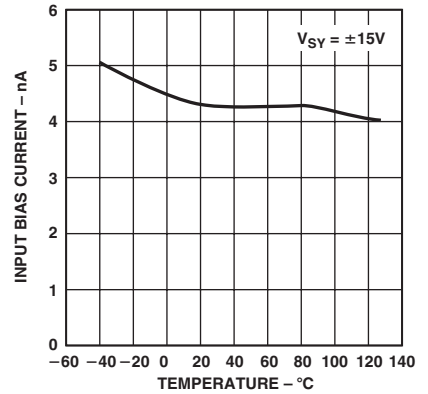
OP777/OP727/OP747



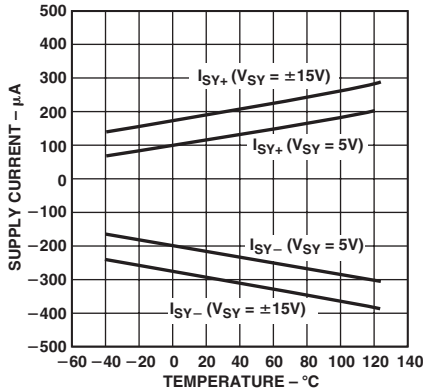
TPC 10. Output Voltage to Supply Rail vs. Load Current



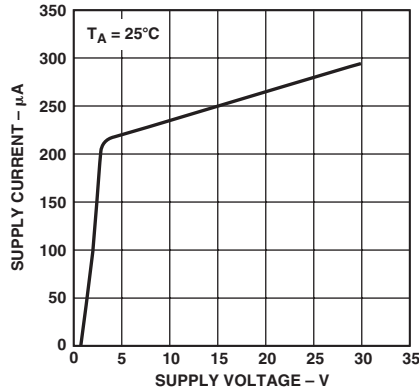
TPC 11. Output Voltage to Supply Rail vs. Load Current



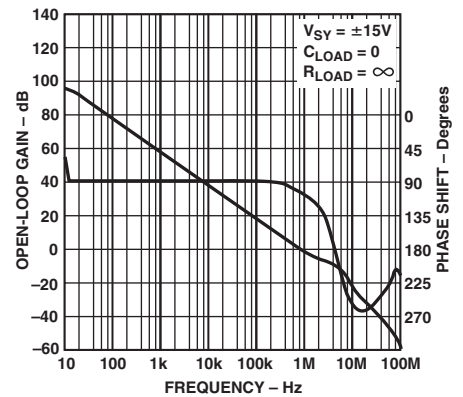
TPC 12. Input Bias Current vs. Temperature



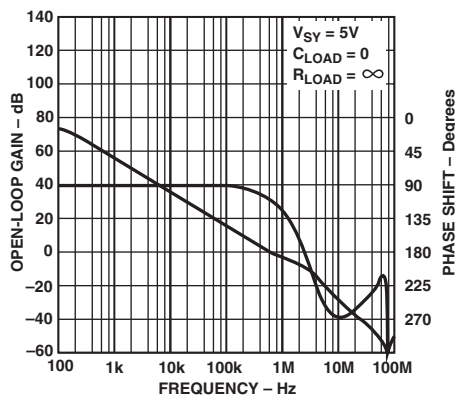
TPC 13. Supply Current vs. Temperature



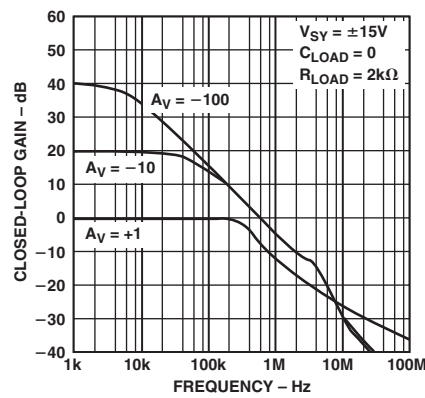
TPC 14. Supply Current vs. Supply Voltage



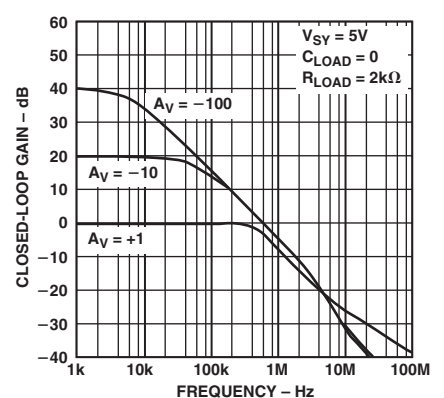
TPC 15. Open Loop Gain and Phase Shift vs. Frequency



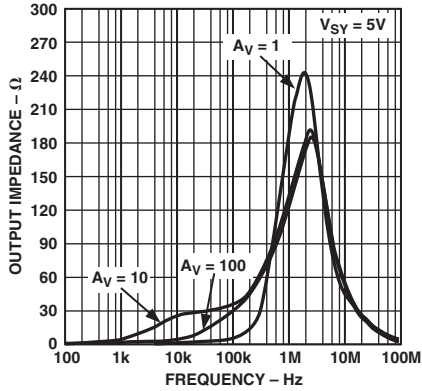
TPC 16. Open Loop Gain and Phase Shift vs. Frequency



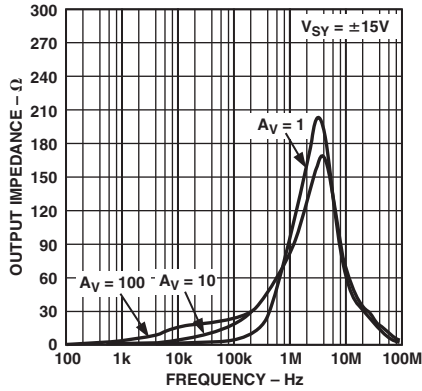
TPC 17. Closed Loop Gain vs. Frequency



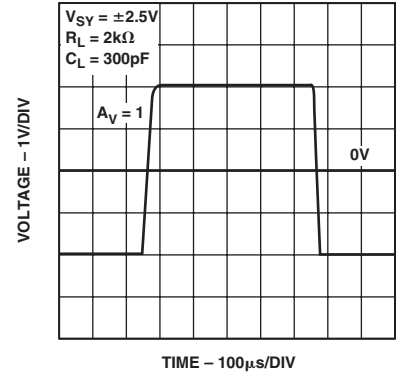
TPC 18. Closed Loop Gain vs. Frequency



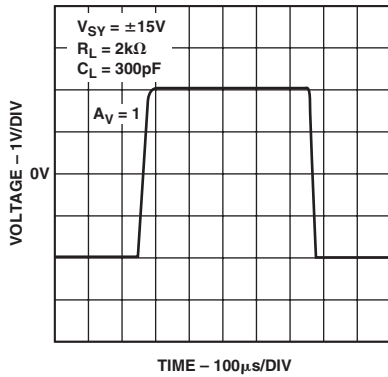
TPC 19. Output Impedance vs. Frequency



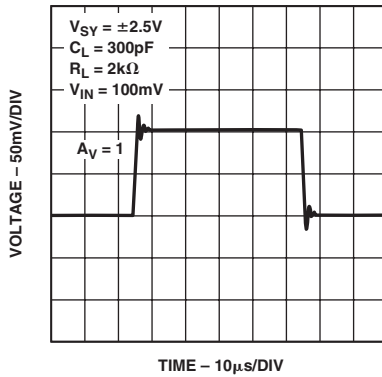
TPC 20. Output Impedance vs. Frequency



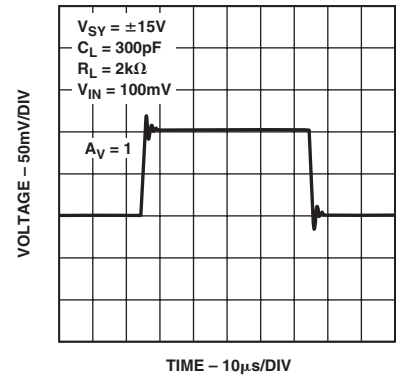
TPC 21. Large Signal Transient Response



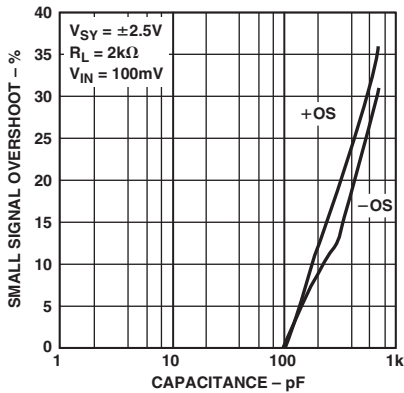
TPC 22. Large Signal Transient Response



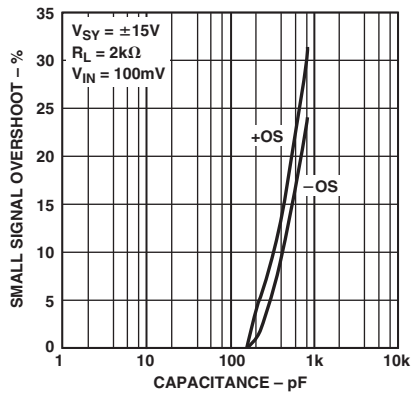
TPC 23. Small Signal Transient Response



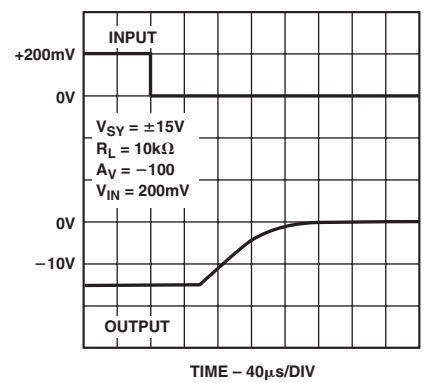
TPC 24. Small Signal Transient Response



TPC 25. Small Signal Overshoot vs. Load Capacitance

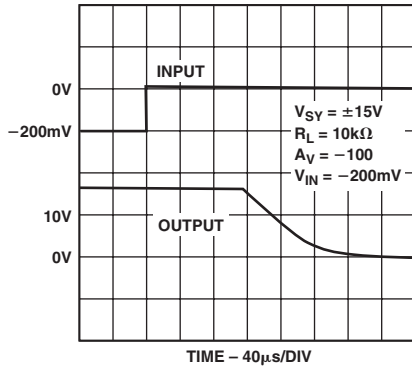


TPC 26. Small Signal Overshoot vs. Load Capacitance

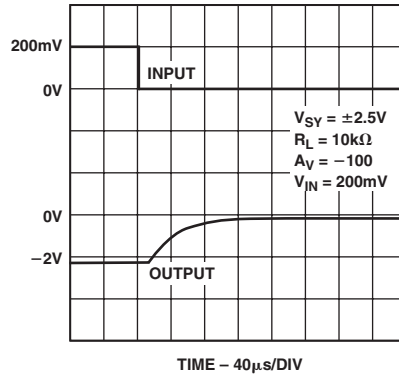


TPC 27. Negative Overvoltage Recovery

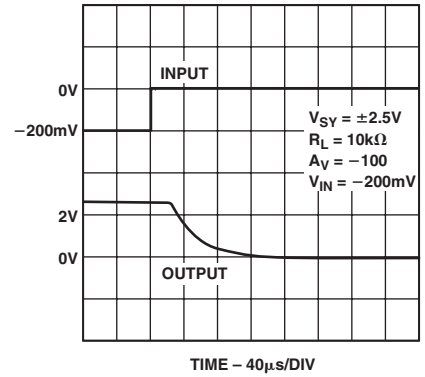
OP777/OP727/OP747



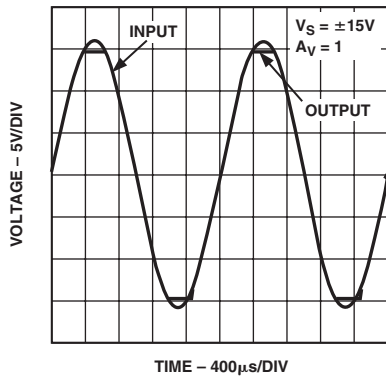
TPC 28. Positive Overvoltage Recovery



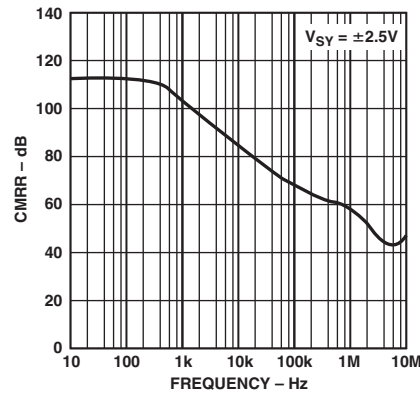
TPC 29. Negative Overvoltage Recovery



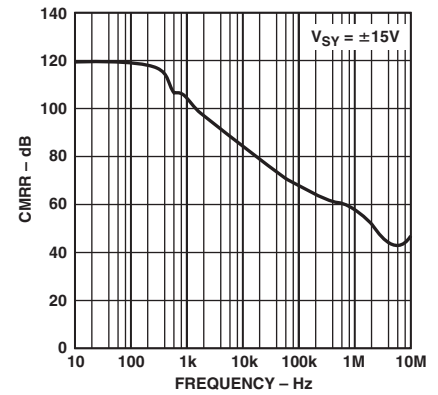
TPC 30. Positive Overvoltage Recovery



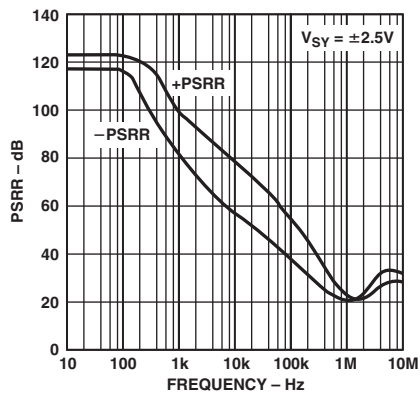
TPC 31. No Phase Reversal



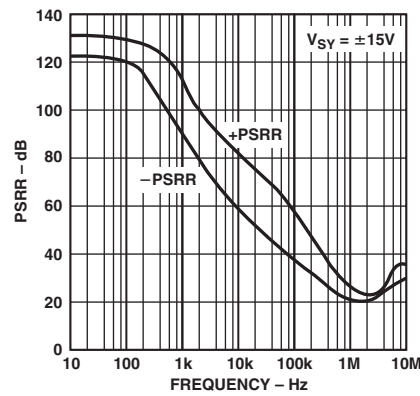
TPC 32. CMRR vs. Frequency



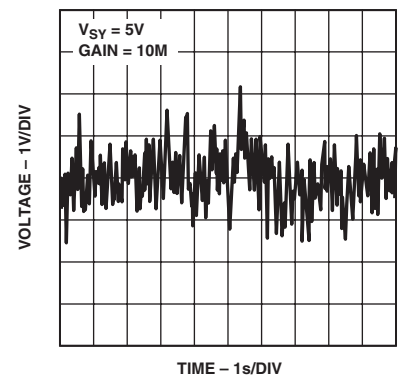
TPC 33. CMRR vs. Frequency



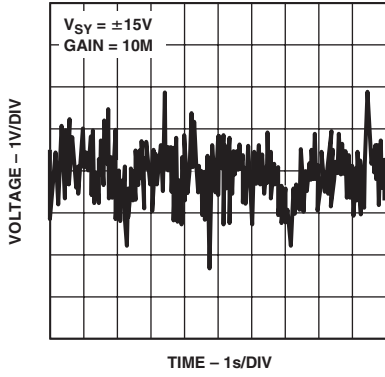
TPC 34. PSRR vs. Frequency



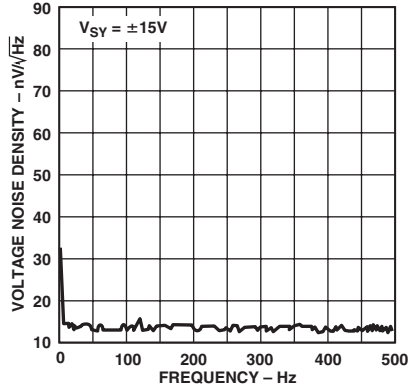
TPC 35. PSRR vs. Frequency



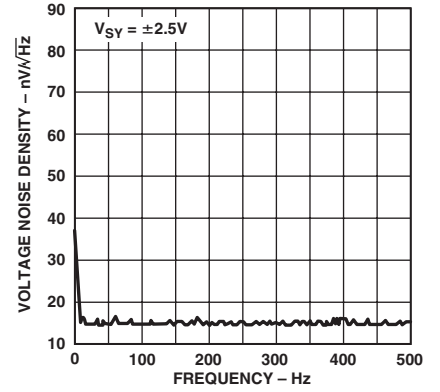
TPC 36. 0.1 Hz to 10 Hz Input Voltage Noise



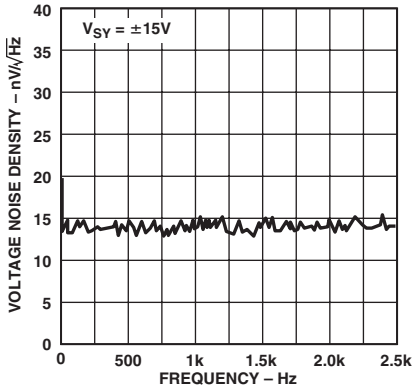
TPC 37. 0.1 Hz to 10 Hz Input Voltage Noise



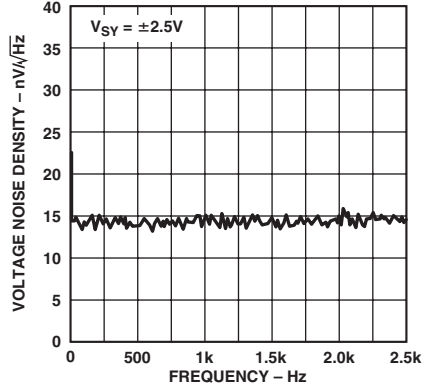
TPC 38. Voltage Noise Density



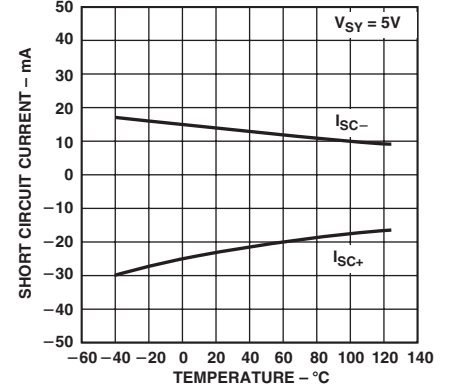
TPC 39. Voltage Noise Density



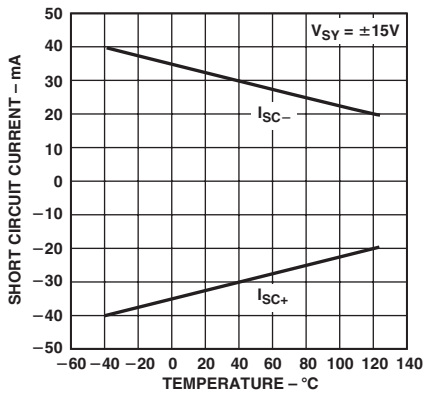
TPC 40. Voltage Noise Density



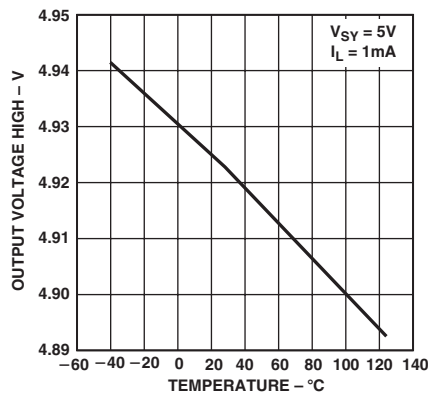
TPC 41. Voltage Noise Density



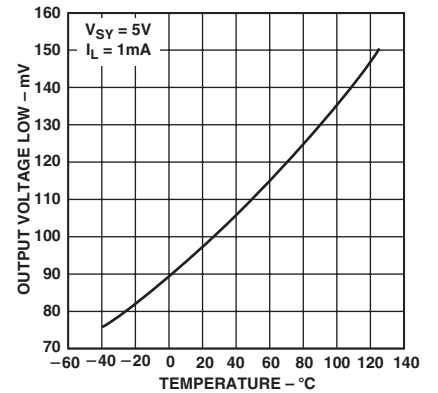
TPC 42. Short Circuit Current vs. Temperature



TPC 43. Short Circuit Current vs. Temperature

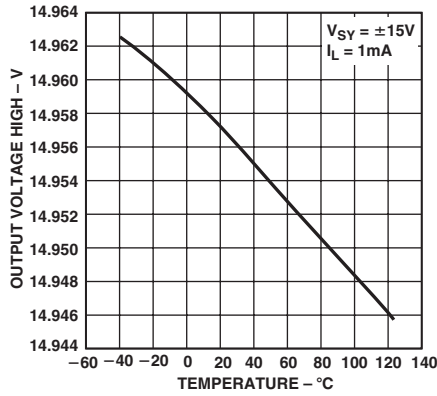


TPC 44. Output Voltage High vs. Temperature

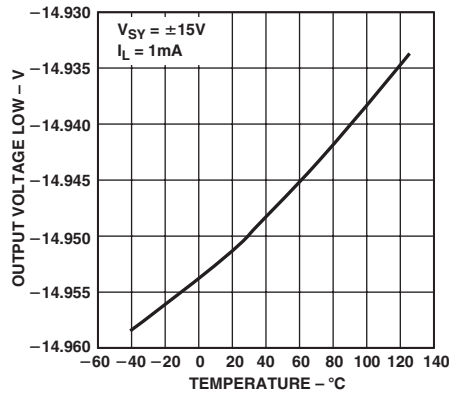


TPC 45. Output Voltage Low vs. Temperature

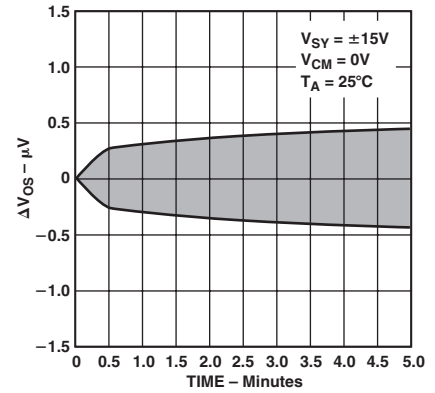
OP777/OP727/OP747



TPC 46. Output Voltage High vs. Temperature



TPC 47. Output Voltage Low vs. Temperature



TPC 48. Warm-Up Drift

BASIC OPERATION

The OP777/OP727/OP747 amplifier uses a precision Bipolar PNP input stage coupled with a high-voltage CMOS output stage. This enables this amplifier to feature an input voltage range which includes the negative supply voltage (often ground in single-supply applications) and also swing to within 1 mV of the output rails. Additionally, the input voltage range extends to within 1 V of the positive supply rail. The epitaxial PNP input structure provides high breakdown voltage, high gain, and an input bias current figure comparable to that obtained with a “Darlington” input stage amplifier but without the drawbacks (i.e., severe penalties for input voltage range, offset, drift and noise). The PNP input structure also greatly lowers the noise and reduces the dc input error terms.

Supply Voltage

The amplifiers are fully specified with a single 5 V supply and, due to design and process innovations, can also operate with a supply voltage from 3.0 V up to 30 V. This allows operation from most split supplies used in current industry practice, with the advantage of substantially increased input and output voltage ranges over conventional split-supply amplifiers. The OP777/OP727/OP747 series is specified with ($V_{SY} = 5\text{ V}$, $V^- = 0\text{ V}$ and $V_{CM} = 2.5\text{ V}$ which is most suitable for single-supply application. With PSRR of 130 dB ($0.3\text{ }\mu\text{V/V}$) and CMRR of 110 dB ($3\text{ }\mu\text{V/V}$) offset is minimally affected by power supply or common-mode voltages. Dual supply, $\pm 15\text{ V}$ operation is also fully specified.

Input Common-Mode Voltage Range

The OP777/OP727/OP747 is rated with an input common-mode voltage which extends from the minus supply to within 1 V of the positive supply. However, the amplifier can still operate with input voltages slightly below V_{EE} . In Figure 2, OP777/OP727/OP747 is configured as a difference amplifier with a single supply of 3.0 V and negative dc common-mode voltages applied at the inputs terminals. A 400 mV p-p input is then applied to the noninverting input. It can be seen from the graph below that the output does not show any distortion. Micropower operation is maintained by using large input and feedback resistors.

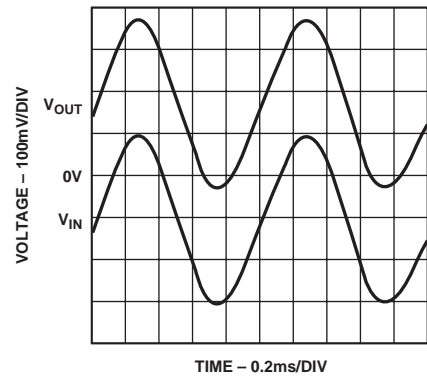


Figure 1. Input and Output Signals with $V_{CM} < 0\text{ V}$

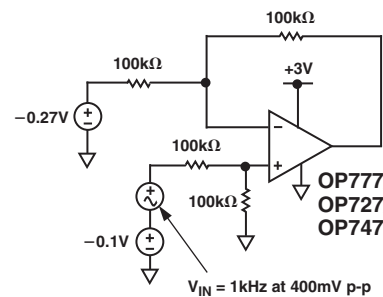


Figure 2. OP777/OP727/OP747 Configured as a Difference Amplifier Operating at $V_{CM} < 0\text{ V}$

Input Over Voltage Protection

When the input of an amplifier is more than a diode drop below V_{EE} , or above V_{CC} , large currents will flow from the substrate (V_{-}) or the positive supply (V_{+}), respectively, to the input pins which can destroy the device. In the case of OP777/OP727/OP747, differential voltages equal to the supply voltage will not cause any problem (see Figure 3). OP777/OP727/OP747 has built-in 500 Ω internal current limiting resistors, in series with the inputs, to minimize the chances of damage. It is a good practice to keep the current flowing into the inputs below 5 mA. In this context it should also be noted that the high breakdown of the input transistors removes the necessity for clamp diodes between the inputs of the amplifier, a feature that is mandatory on many precision op amps. Unfortunately, such clamp diodes greatly interfere with many application circuits such as precision rectifiers and comparators. The OP777/OP727/OP747 series is free from such limitations.

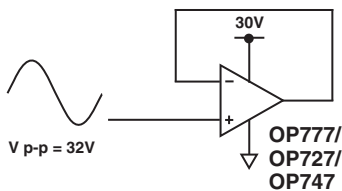


Figure 3a. Unity Gain Follower

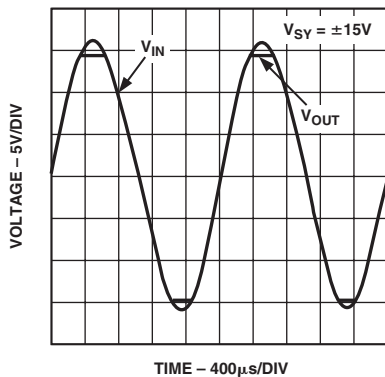


Figure 3b. Input Voltage Can Exceed the Supply Voltage Without Damage

Phase Reversal

Many amplifiers misbehave when one or both of the inputs are forced beyond the input common-mode voltage range. Phase reversal is typified by the transfer function of the amplifier effectively reversing its transfer polarity. In some cases this can cause lockup in servo systems and may cause permanent damage or nonrecoverable parameter shifts to the amplifier. Many amplifiers feature compensation circuitry to combat these effects, but some are only effective for the inverting input. Additionally, many of these schemes only work for a few hundred millivolts or so beyond the supply rails. OP777/OP727/OP747 has a protection circuit against phase reversal when one or both inputs are forced beyond their input common-mode voltage range. It is not recommended that the parts be continuously driven more than 3 V beyond the rails.

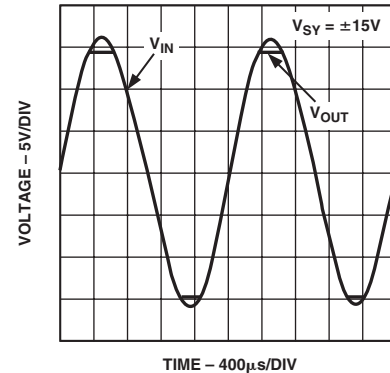


Figure 4. No Phase Reversal

Output Stage

The CMOS output stage has excellent (and fairly symmetric) output drive and with light loads can actually swing to within 1 mV of both supply rails. This is considerably better than similar amplifiers featuring (so-called) rail-to-rail bipolar output stages. OP777/OP727/OP747 is stable in the voltage follower configuration and responds to signals as low as 1 mV above ground in single supply operation.

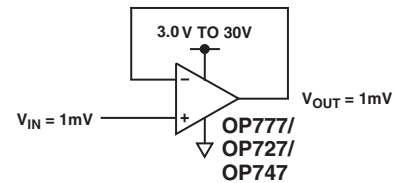


Figure 5. Follower Circuit

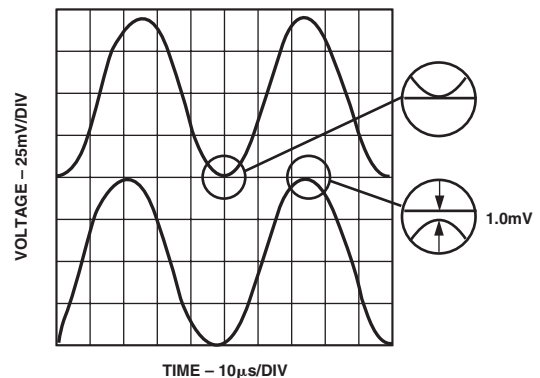


Figure 6. Rail-to-Rail Operation

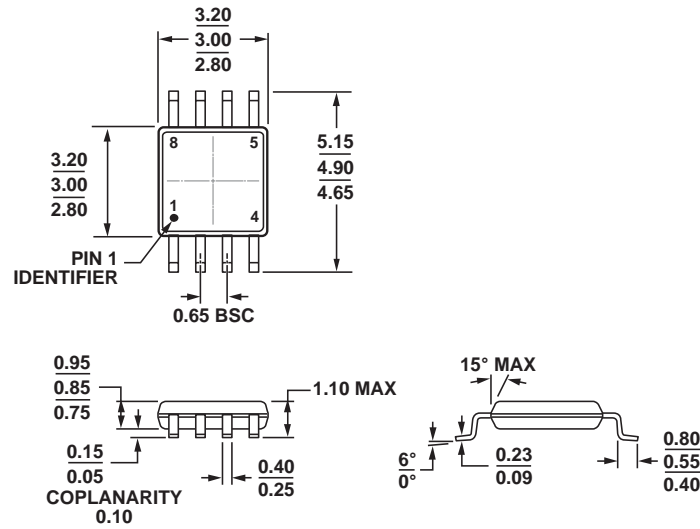
Output Short Circuit

The output of the OP777/OP727/OP747 series amplifier is protected from damage against accidental shorts to either supply voltage, provided that the maximum die temperature is not exceeded on a long-term basis (see Absolute Maximum Rating section). Current of up to 30 mA does not cause any damage.

A Low-Side Current Monitor

In the design of power supply control circuits, a great deal of design effort is focused on ensuring a pass transistor's long-term reliability over a wide range of load current conditions. As a result, monitoring

OUTLINE DIMENSIONS

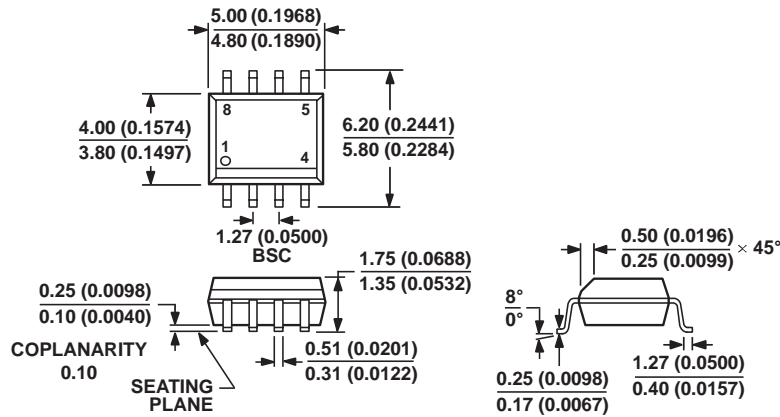


COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 12. 8-Lead Mini Small Outline Package [MSOP] (RM-8)

Dimensions shown in millimeters

10-07-2009-B



COMPLIANT TO JEDEC STANDARDS MS-012-AA

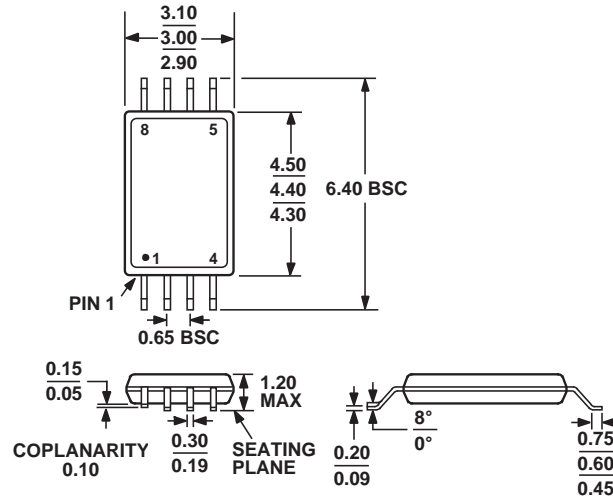
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 13. 8-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-8)

Dimensions shown in millimeters and (inches)

012407-A

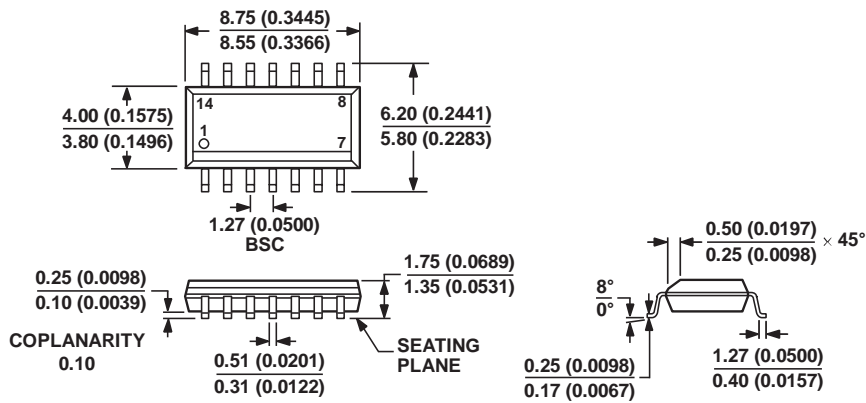
OP777/OP727/OP747



COMPLIANT TO JEDEC STANDARDS MO-153-AA

Figure 14. 8-Lead Thin Shrink Small Outline Package [TSSOP] (RU-8)

Dimensions shown in millimeters



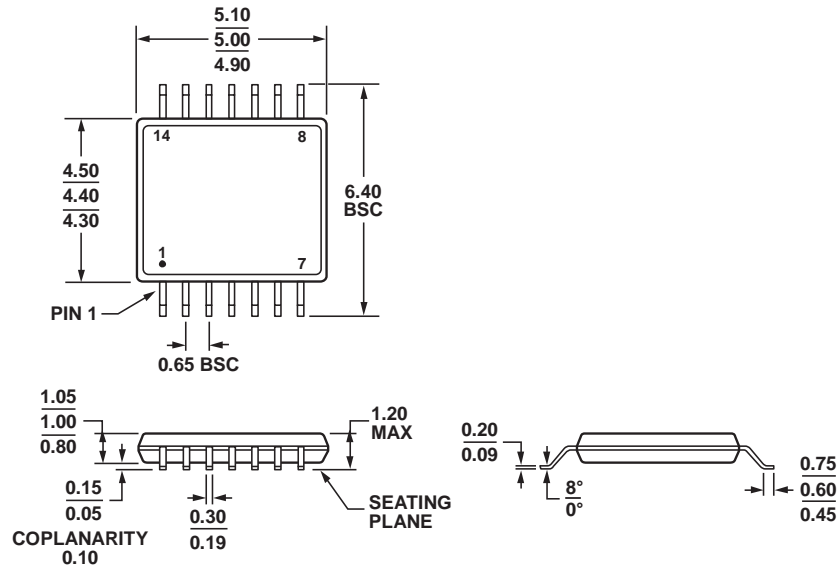
COMPLIANT TO JEDEC STANDARDS MS-012-AB

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 15. 14-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-14)

Dimensions shown in millimeters and (inches)

060606-A



COMPLIANT TO JEDEC STANDARDS MO-153-AB-1

Figure 16. 14-Lead Thin Shrink Small Outline Package [TSSOP] (RU-14)

Dimensions shown in millimeters

061908-A

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Branding
OP727AR	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP727AR-REEL	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP727AR-REEL7	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP727ARUZ	-40°C to +85°C	8-Lead TSSOP	RU-8	
OP727ARUZ-REEL	-40°C to +85°C	8-Lead TSSOP	RU-8	
OP727ARZ	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP727ARZ-REEL	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP727ARZ-REEL7	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP747ARU	-40°C to +85°C	14-Lead TSSOP	RU-14	
OP747ARU-REEL	-40°C to +85°C	14-Lead TSSOP	RU-14	
OP747ARUZ	-40°C to +85°C	14-Lead TSSOP	RU-14	
OP747ARUZ-REEL	-40°C to +85°C	14-Lead TSSOP	RU-14	
OP747ARZ	-40°C to +85°C	14-Lead SOIC	R-14	
OP747ARZ-REEL	-40°C to +85°C	14-Lead SOIC	R-14	
OP747ARZ-REEL7	-40°C to +85°C	14-Lead SOIC	R-14	
OP777ARMZ	-40°C to +85°C	8-Lead MSOP	RM-8	A1A
OP777ARMZ-REEL	-40°C to +85°C	8-Lead MSOP	RM-8	A1A
OP777ARZ	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP777ARZ-REEL	-40°C to +85°C	8-Lead SOIC_N	R-8	
OP777ARZ-REEL7	-40°C to +85°C	8-Lead SOIC_N	R-8	

¹ Z = RoHS Compliant Part.

OP777/OP727/OP747

REVISION HISTORY

10/11—Rev. C to Rev. D

Changed Single Supply Operation from 2.7 V to 30 V to 3.0 V to 30 V	1
Changed Dual Supply Operation from ± 1.35 V to ± 15 V to ± 1.5 V to ± 15 V	1
Changes to General Description Section	1
Added Similar Low Power Products Table.....	1
Changes to Supply Voltage Section, Input Common-Mode Voltage Range Section, and Figure 1	10
Changes to Figure 5.....	11
Changes to Figure 10 and Figure 11.....	12
Updated Outline Dimensions	13
Changes to Ordering Guide	15

9/01—Rev. B to Rev. C

Addition of text to Applications Section	1
Addition of 8-Lead SOIC (R-8) Package	1
Addition of text to General Description.....	1
Addition of package to Ordering Guide.....	2

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru